# EL9200, EL9201, EL9202



Data Sheet

#### October 30, 2008

# FN7438.1

# Programmable V<sub>COM</sub>

The EL9200, EL9201, and EL9202 represent programmable V<sub>COM</sub> amplifiers for use in TFT-LCD displays. Featuring 1, 2, and 4 channels of V<sub>COM</sub> amplification, respectively, each device features just a single programmable current source for adding offset to one V<sub>COM</sub> output. This current source is programmable using a single wire interface to one of 128 levels. The value is stored on an internal EEPROM memory.

The EL9200 is available in the 12 LD DFN package and the EL9201 and EL9202 are available in 24 LD QFN packages. All are specified for operation over the -40°C to +85°C temperature range.

# Typical Block Diagram



## Features

- 128 Step Adjustable Sink Current
- EEPROM Memory
- · 2-pin Adjustment and Disable
- · Single, Dual or Quad Amplifiers
  - 44MHz Bandwidth
  - 80V/µs Slew Rate
  - 60mA Continuous Output
  - 180mA Peak Output
- Up to 18V Operation
- 2.6V to 3.6VLogic Control
- · Pb-free Available (RoHS compliant)

# **Applications**

- TFT-LCD V<sub>COM</sub> Supplies For
  - LCD-TVs
  - LCD Monitors



CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures. 1-888-INTERSIL or 1-888-468-3774 | Intersil (and design) is a registered trademark of Intersil Americas Inc. Copyright Intersil Americas Inc. 2005, 2008. All Rights Reserved All other trademarks mentioned are the property of their respective owners.

## Pinouts

# **Ordering Information**

PART NUMBER	PART MARKING	TEMP RANGE (°C)	PACKAGE	PKG. DWG. #
EL9200IL	9200IL	-40 to +85	12 LD DFN	L12.4x4B
EL9200IL-T7*	9200IL	-40 to +85	12 LD DFN	L12.4x4B
EL9200IL-T13*	9200IL	-40 to +85	12 LD DFN	L12.4x4B
EL9200ILZ (Note)	9200ILZ	-40 to +85	12 LD DFN (Pb-Free)	L12.4x4B
EL9200ILZ-T7* (Note)	9200ILZ	-40 to +85	12 LD DFN (Pb-Free)	L12.4x4B
EL9200ILZ-T13* (Note)	9200ILZ	-40 to +85	12 LD DFN (Pb-Free)	L12.4x4B
EL9201IL	92011L	-40 to +85	24 LD QFN	MDP0046
EL9201IL-T7*	9201IL	-40 to +85	24 LD QFN	MDP0046
EL9201IL-T13*	9201IL	-40 to +85	24 LD QFN	MDP0046
EL9201ILZ (Note)	9202ILZ	-40 to +85	24 LD QFN (Pb-Free)	MDP0046
EL9201ILZ-T7* (Note)	9202ILZ	-40 to +85	24 LD QFN (Pb-Free)	MDP0046
EL9201ILZ-T13* (Note)	9202ILZ	-40 to +85	24 LD QFN (Pb-Free)	MDP0046
EL9202IL	9202IL	-40 to +85	24 LD QFN	MDP0046
EL9202IL-T7*	9202IL	-40 to +85	24 LD QFN	MDP0046
EL9202IL-T13*	9202IL	-40 to +85	24 LD QFN	MDP0046
EL9202ILZ (Note)	9202ILZ	-40 to +85	24 LD QFN (Pb-Free)	MDP0046
EL9202ILZ-T7* (Note)	9202ILZ	-40 to +85	24 LD QFN	MDP0046
EL9202ILZ-T13* (Note)	9202ILZ	-40 to +85	24 LD QFN (Pb-Free)	MDP0046

\*Add "-T" suffix for tape and reel \*Please refer to TB347 for details on reel specifications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

#### Absolute Maximum Ratings (T<sub>A</sub> = +25°C)

V <sub>S</sub> + Supply Voltage between V <sub>S</sub> + and GND
Maximum Continuous Output Current
Input Voltages to GND
SET, CE0.3V to +4V
CTL0.3V to +16V
Output Voltages to GND
OUT0.3V to +20V
A <sub>VDD</sub> 0.3V to +20V
ESD Rating
Human Body Model

#### **Thermal Information**

Maximum Die Temperature+150°C	)
Storage Temperature65°C to +150°C	)
Pb-Free Reflow Profile	/
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

#### **Operating Conditions**

Ambient Operating	Temperature	40°C to +85°C
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CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$ 

<b>Electrical Specifications</b>	V <sub>SD</sub> = 3V, V <sub>S</sub> + = 15V, A <sub>VDD</sub> = 15V, R <sub>SFT</sub> = 24.9kΩ,	and $T_A = +25^{\circ}C$ unless otherwise specified
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PARAMETER	DESCRIPTION	CONDITION	MIN	ТҮР	МАХ	UNIT
V <sub>S+</sub>	Supply Voltage		4.5		16.5	V
I <sub>S+</sub>	Quiescent Current	EL9200		3.8	4.8	mA
		EL9201		7.6	9.6	mA
		EL9202		10.5	16	mA
V <sub>SD</sub>	Logic Supply Voltage	For programming	3		3.6	V
		For operation	2.6		3.6	V
I <sub>SD</sub>	Quiescent Logic Current	CE = 3.6V			50	μA
		CE = GND			25	μA
		Program (charge pump current) (Note 1)			23	mA
		Read (Note 1)			3	mA
IADD	Supply Current	(Note 2)			25	μA
CTLIH	CTL High Voltage	2.6V < V <sub>SD</sub> < 3.6V	0.7*V <sub>SD</sub>		0.8*V <sub>SD</sub>	V
CTL <sub>IL</sub>	CTL Low Voltage	2.6V < V <sub>SD</sub> < 3.6V	0.2*V <sub>SD</sub>		0.3*V <sub>SD</sub>	V
CTLIHRPW	CTL High Rejected Pulse Width		20			μs
CTLILRPW	CTL Low Rejected Pulse Width		20			μs
CTLIHMPW	CTL High Minimum Pulse Width		200			μs
CTLILMPW	CTL Low Minimum Pulse Width				200	μs
CTL <sub>MTC</sub>	CTL Minimum Time Between Counts			10		μs
ICTL	CTL Input Current	CTL = GND			10	μA
		CTL = V <sub>SD</sub>			10	μA
CTL <sub>CAP</sub>	CTL Input Capacitance			10		pF
CEIL	CE Input Low Voltage	2.6V < V <sub>SD</sub> < 3.6V			0.4	V
CEIH	CE Input High Voltage	2.6V < V <sub>SD</sub> < 3.6V	1.6			V
CE <sub>ST</sub>	CE Minimum Start-Up Time	(Note 1)	1			ms
CTL <sub>PROM</sub>	CTL EEPROM Program Voltage	2.6V < V <sub>SD</sub> < 3.6V (Note 2)	4.9		15.75	V
CTL <sub>PT</sub>	CTL EEPROM Programming Signal Time	> 4.9V	200			μs
P <sub>T</sub>	Programming Time			100		ms
EE <sub>WC</sub>	EE Write Cycles	(Note 5)	1000			cycles

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# EL9200, EL9201, EL9202

Electrical Spe	ecifications $V_{SD} = 3V, V_{S^+} = 15V, J$	$A_{VDD}$ = 15V, $R_{SET}$ = 24.9k $\Omega$ , and $T_A$ = +25°C	unless otherwis	e specified	d. (Contin	ued)
PARAMETER	DESCRIPTION	CONDITION	MIN	ТҮР	МАХ	UNIT
SET <sub>DN</sub>	SET Differential Nonlinearity	Monotonic over-temperature		±1		LSB
SET <sub>ZSE</sub>	SET Zero-Scale Error	(Note 3)			±2	LSB
SET <sub>FSE</sub>	SET Full-Scale Error	(Note 3)			±8	LSB
I <sub>SET</sub>	SET Current	Through R <sub>SET</sub> (Note 1)			120	μA
SET <sub>ER</sub>	SET External Resistance	To GND, A <sub>VDD</sub> = 20V (Note 1)	10		200	kΩ
		To GND, A <sub>VDD</sub> = 4.5V (Note 1)	2.25		45	kΩ
A <sub>VDD</sub> to SET	A <sub>VDD</sub> to SET Voltage Attenuation			1:20		V/V
OUT <sub>ST</sub>	OUT Settling Time	To ±0.5 LSB error band (Note 1)		20		μs
V <sub>OUT</sub>	OUT Voltage Range	(Note 1)	V <sub>SET</sub> + 0.5V		13	V
OUT <sub>VD</sub>	OUT Voltage Drift	(Note 1)			10	mV
AMPLIFIER CH	ARACTERISTICS		1			
INPUT CHARAC	TERISTICS					
V <sub>OS</sub>	Input Offset Voltage	V <sub>CM</sub> = 0V		3	15	mV
TCV <sub>OS</sub>	Average Offset Voltage Drift (Note 1)			7		μV/°C
IB	Input Bias Current	V <sub>CM</sub> = 0V		2	60	nA
R <sub>IN</sub>	Input Impedance			1		GΩ
C <sub>IN</sub>	Input Capacitance			2		pF
CMRR	Common-Mode Rejection Ratio	For V <sub>IN</sub> from -5.5V to +5.5V	50	70		dB
A <sub>VOL</sub>	Open-Loop Gain	$-4.5V \le V_{OUT} \le +4.5V$	60	70		dB
OUTPUT CHAR	ACTERISTICS		· · · · · ·			
V <sub>OL</sub>	Output Swing Low	$R_L = 1.5 k\Omega$ to 0		0.09	0.15	V
V <sub>OH</sub>	Output Swing High		14.85	14.9		V
I <sub>SC</sub>	Short-Circuit Current		±150	±180		mA
IOUT	Output Current			±65		mA
POWER SUPPL	Y PERFORMANCE		•			
PSRR	Power Supply Rejection Ratio	$V_{S+}$ is moved from 4.5V to 15.5V	55	80		dB
DYNAMIC PERF	ORMANCE		· · · · ·			
SR	Slew Rate (Note 4)	-4.0V $\leq$ V_OUT $\leq$ 4.0V, 20% to 80%	60	80		V/µs
t <sub>S</sub>	Settling to +0.1% ( $A_V = +1$ )	$(A_V = +1), V_{OUT} = 2V \text{ step}$		80		ns
BW	-3dB Bandwidth			44		MHz
GBWP	Gain-Bandwidth Product			32		MHz
PM	Phase Margin			50		0
CS	Channel Separation	f = 5MHz (EL9201 and EL9202 only)		110		dB
d <sub>G</sub>	Differential Gain (Note 5)	$R_F = R_G = 1k\Omega$ and $V_{OUT} = 1.4V$		0.17		%
dP	Differential Phase (Note 5)	$R_F = R_G = 1k\Omega$ and $V_{OUT} = 1.4V$		0.24		0

NOTES:

1. Simulated and determined via design and not directly tested

- 2. Tested at  $A_{VDD} = 20V$
- 3. Wafer sort only
- 4. NTSC signal generator used

5. Limits established by characterization and are not production tested.

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## **Pin Descriptions**

PIN	IN/OUT	DESCRIPTION	EQUIVALENT CIRCUIT
VINx-	Input	Amplifier x inverting input, where: x = A for EL9200 x = A, B for EL9201 x = A, B, C, D for EL9202	VS+
VINx+	Input	Amplifier x non-inverting input, where: x = A for EL9200 x = A, B for EL9201 x = A, B, C, D for EL9202	Reference Circuit 1
VS+	Supply	Op amp supply; bypass to GND with $0.1 \mu F$ capacitor	
VOUTX	Output	Amplifier X output, where: x = A for EL9200 x = A, B for EL9201 x = A, B, C, D for EL9202	······································
NC	-	No connect; not internally connected	
GND	Supply	Ground connection	
IOUT	Output	Adjustable sink current output pin; the current sinks into the OUT pin is equal to the DAC setting times the maximum adjustable sink current divided by 128; see SET pin function description for the maxim adjustable sink current setting	
SET	Output	Maximum sink current adjustment point; connect a resistor from SET to GND to set the maximum adjustable sink current of the OUT pin; the maximum adjustable sink current is equal to (A <sub>VDD</sub> /20) divided by R <sub>SET</sub>	
CE	Input	Counter enable pin; connect CE to V <sub>DD</sub> to enable counting of the internal counter; connect CE to GND to inhibit counting	
CTL	Input	Internal counter up/down control and internal EEPROM programming control input; if CE is high, a mid-to-low transition increments the 7-bit counter, raising the DAC setting, increasing the OUT sink current, and lowering the divider voltage at OUT; a mid-to-high transition decrements the 7-bit counter, lowering the DAC setting, decreasing the OUT sink current, and increasing the divider voltage at OUT; applying 4.9V and above with appropriately arranged timing will overwrite EEPROM with the contents in the 7-bit counter; see EEPROM Programming section for details	
AVDD	Supply	Analog voltage supply; bypass to GND with $0.1 \mu F$ capacitor	
VSD	Supply	System power supply input; bypass to GND with $0.1 \mu \text{F}$ capacitor	

# Amplifier Typical Performance Curves



FIGURE 1. INPUT OFFSET VOLTAGE DISTRIBUTION



FIGURE 3. INPUT OFFSET VOLTAGE DRIFT



FIGURE 5. INPUT OFFSET VOLTAGE vs TEMPERATURE



FIGURE 2. INPUT BIAS CURRENT vs TEMPERATURE











FIGURE 7. OPEN-LOOP GAIN vs TEMPERATURE



FIGURE 9. DIFFERENTIAL GAIN



FIGURE 11. HARMONIC DISTORTION vs VOP-P



FIGURE 8. SLEW RATE vs TEMPERATURE



FIGURE 10. DIFFERENTIAL PHASE



FIGURE 12. OPEN LOOP GAIN AND PHASE



FIGURE 13. FREQUENCY RESPONSE FOR VARIOUS RL



FIGURE 15. CLOSED LOOP OUTPUT IMPEDANCE



FIGURE 17. CMRR



FIGURE 14. FREQUENCY RESPONSE FOR VARIOUS CL







FIGURE 18. PSRR



FIGURE 19. INPUT VOLTAGE NOISE SPECTRAL DENSITY



FIGURE 21. SMALL-SIGNAL OVERSHOOT vs LOAD CAPACITANCE



FIGURE 23. LARGE SIGNAL TRANSIENT RESPONSE



FIGURE 20. CHANNEL SEPARATION



FIGURE 22. SETTLING TIME vs STEP SIZE



FIGURE 24. SMALL SIGNAL TRANSIENT RESPONSE



FIGURE 25. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

# Application Information

This device provides the ability to reduce the flicker of an LCD panel by adjustment of the  $V_{COM}$  voltage during production test and alignment. A 128-step resolution is provided under digital control which adjusts the sink current of the output. The output is connected to an external voltage divider, so that the device will have the capability to reduce the voltage on the output by increasing the output sink current.

The adjustment of the output and the programming of the non-volatile memory are provided on one pin while the counter enable (CE) is provided on a separate pin. The output is adjusted via the CTL pin either by counting up with a mid to low transition or by counting down with a mid to high transition. Once the minimum or maximum value is reached on the 128 steps, the device will not overflow or underflow beyond that minimum or maximum value. An increment of the counter will increase the output sink current which will lower the voltage on the external voltage divider. A decrement of the counter will decrease the output sink current, which will raise the voltage on the external voltage divider.

Once the desired output level is obtained, the part can store it's setting using the non-volatile memory in the device. See the "Non-Volatile Memory (EEPROM) Programming" on page 12 for detailed information.

Note: Once the desired output level is stored in the EEPROM, the CE pin must go low to preserve the stored value.



FIGURE 26. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

#### Adjustable Sink Current Output

The device provides an output sink current which lowers the voltage on the external voltage divider. The equations that control the output are given in Equation 1:

$$I_{OUT} = \frac{\text{Setting}}{128} \times \frac{A_{VDD}}{20(R_{SET})}$$

$$V_{OUT} = \left(\frac{R_2}{R_1 + R_2}\right) V_{AVDD} \left(1 - \frac{\text{Setting}}{128} \times \frac{R_1}{20(R_{SET})}\right)$$
(EQ. 1)

NOTE: Where setting is an integer between 1 and 128.

#### 7-Bit Up/Down Counter

The counter sets the level to the digital potentiometer and is connected to the non-volatile memory. When the part is programmed, the counter setting is loaded into the non-volatile memory. This value will be loaded from the non-volatile memory into the counter during power-on. The counter will not exceed its maximum level and will hold that value during subsequent increment requests on the CTL pin. The counter will not exceed its minimum level and will hold that value during subsequent decrement requests on the CTL pin.

#### CTL Pin

CTL should have a noise filter to reduce bouncing or noise on the input that could cause unwanted counting when the CE pin is high. The board should have an additional ESD protection circuit, with a series  $1k\Omega$  resistor and a shunt  $0.01\mu$ F capacitor connected on the CTL pin.

In order to increment the setting, pulse CTL low for more than 200 $\mu$ s. The output sink current increases and lowers the V<sub>COM</sub> lever by one least-significant bit (LSB). On the other hand, to decrement the setting, pulse CTL high for

more than 200 $\mu s.$  The output sink current will decrease and the  $V_{COM}$  level will increase by one LSB.

To avoid unintentional adjustment, the EL9200, EL9201, and EL9202 guarantees to reject CTL pulses shorter than 20µs.

Since the internal comparators come up in an unknown state, the very first CTL pulse is ignored to avoid the possibility of a false pulse.

See Figure 27 for the timing information.

IADLE I. INUTH IADLE								
	INPUT		OUTPUT					
CTL	CE	V <sub>DD</sub>	SET	Icc	MEMORY			
Mid to Hi	Hi	V <sub>DD</sub>	Decrement	Normal	Х			
Mid to Lo	Hi	V <sub>DD</sub>	Increment	Normal	Х			
Х	Lo	V <sub>DD</sub>	No Change	Lower	Х			
> 4.9V	X	V <sub>DD</sub>	No Change	Increased	Program			
Х	X	0 to V <sub>DD</sub>	Read	Increased	Read			

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NOTE: CE should be disabled (pulled low) before powering down the device to assure that the glitches and transients will not cause unwanted EEPROM overwriting.



FIGURE 27. V<sub>COM</sub> ADJUSTMENT

# Non-Volatile Memory (EEPROM) Programming

When the CTL pin exceeds 4.9V, the non-volatile programming cycle will be activated. The CTL signal needs to remain above 4.9V for more than  $200\mu$ s. The level and timing needed to program the non-volatile memory is given below. It then takes a maximum of 100ms for the programming to be completed inside the device (see P<sub>T</sub> specification in Table Electrical Specifications on page 3.



FIGURE 28. EEPROM PROGRAMMING

#### Amplifiers' Operating Voltage, Input, and Output

The amplifiers are specified with a single nominal supply voltage from 5V to 15V or a split supply with its total range from 5V to 15V. Correct operation is guaranteed for a supply range of 4.5V to 16.5V. Most amplifier specifications are stable over both the full supply range and operating temperatures of -40°C to +85°C. Parameter variations with operating voltage and/or temperature are shown in the See "Amplifier Typical Performance Curves" on page 6.

The input common-mode voltage range of the amplifiers extends 500mV beyond the supply rails. The output swings of the those typically extend to within 100mV of positive and negative supply rails with load currents of 5mA. Decreasing load currents will extend the output voltage range even closer to the supply rails. Figure 27 shows the input and output waveforms for the device in the unity-gain configuration. Operation is from 5V supply with a 1k $\Omega$  load connected to GND. The input is a 10V<sub>P-P</sub> sinusoid. The output voltage is approximately 9.8V<sub>P-P</sub>.



FIGURE 29. OPERATION WITH RAIL-TO-RAIL INPUT AND OUTPUT

#### Short-Circuit Current Limit

The amplifiers will limit the short circuit current to  $\pm 180$ mA if the output is directly shorted to the positive or the negative supply. If an output is shorted indefinitely, the power dissipation could easily increase such that the device may be damaged. Maximum reliability is maintained if the output continuous current never exceeds  $\pm 65$ mA. This limit is set by the design of the internal metal interconnects.

#### **Output Phase Reversal**

The amplifiers are immune to phase reversal as long as the input voltage is limited from V<sub>S<sup>-</sup></sub> -0.5V to V<sub>S<sup>+</sup></sub> +0.5V. Figure 28 shows a photo of the output of the device with the input voltage driven beyond the supply rails. Although the device's output will not change phase, the input's overvoltage should be avoided. If an input voltage exceeds supply voltage by more than 0.6V, electrostatic protection diodes placed in the input stage of the device begin to conduct and over-voltage damage could occur.



#### FIGURE 30. OPERATION WITH BEYOND-THE-RAILS INPUT

#### **Unused Amplifiers**

It is recommended that any unused amplifiers in a dual and a quad package be configured as a unity gain follower. The inverting input should be directly connected to the output and the non-inverting input tied to the ground plane.

# Power Supply Bypassing and Printed Circuit Board Layout

The amplifiers can provide gain at high frequency. As with any high-frequency device, good printed circuit board layout is necessary for optimum performance. Ground plane construction is highly recommended, lead lengths should be as short as possible and the power supply pins must be well bypassed to reduce the risk of oscillation. For normal operation, a  $0.1\mu$ F ceramic capacitor should be placed from V<sub>S</sub> to pin to GND. A  $4.7\mu$ F tantalum capacitor should then be connected in parallel, placed in the region of the amplifier.

# Replacing Existing Mechanical Potentiometer Circuits

Figures 29 and 30 show the common adjustment mechanical circuits and equivalent replacement with the EL920x.







FIGURE 32. EXAMPLE OF THE REPLACEMENT FOR THE MECHANICAL POTENTIOMETER CIRCUIT USING THE EL9200

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# QFN (Quad Flat No-Lead) Package Family





BOTTOM VIEW





#### **MDP0046**

QFN (QUAD FLAT NO-LEAD) PACKAGE FAMILY (COMPLIANT TO JEDEC MO-220)

		MILLIM	IETER	S		
SYMBOL	QFN44	QFN38	QFN32		TOLERANCE	NOTES
Α	0.90	0.90	0.90	0.90	±0.10	-
A1	0.02	0.02	0.02	0.02	+0.03/-0.02	-
b	0.25	0.25	0.23	0.22	±0.02	-
С	0.20	0.20	0.20	0.20	Reference	-
D	7.00	5.00	8.00	5.00	Basic	-
D2	5.10	3.80	5.80	3.60/2.48	Reference	8
E	7.00	7.00	8.00	6.00	Basic	-
E2	5.10	5.80	5.80	4.60/3.40	Reference	8
е	0.50	0.50	0.80	0.50	Basic	-
L	0.55	0.40	0.53	0.50	±0.05	-
Ν	44	38	32	32	Reference	4
ND	11	7	8	7	Reference	6
NE	11	12	8	9	Reference	5

	MILLIMETERS					TOLER-		
SYMBOL	QFN28	QFN24	QFN20		QFN16	ANCE	NOTES	
A	0.90	0.90	0.90	0.90	0.90	±0.10	-	
A1	0.02	0.02	0.02	0.02	0.02	+0.03/ -0.02	-	
b	0.25	0.25	0.30	0.25	0.33	±0.02	-	
С	0.20	0.20	0.20	0.20	0.20	Reference	-	
D	4.00	4.00	5.00	4.00	4.00	Basic	-	
D2	2.65	2.80	3.70	2.70	2.40	Reference	-	
E	5.00	5.00	5.00	4.00	4.00	Basic	-	
E2	3.65	3.80	3.70	2.70	2.40	Reference	-	
е	0.50	0.50	0.65	0.50	0.65	Basic	-	
L	0.40	0.40	0.40	0.40	0.60	±0.05	-	
Ν	28	24	20	20	16	Reference	4	
ND	6	5	5	5	4	Reference	6	
NE	8	7	5	5	4	Reference	5	
Rev 11 2/07								

NOTES:

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Tiebar view shown is a non-functional feature.
- 3. Bottom-side pin #1 I.D. is a diepad chamfer as shown.
- 4. N is the total number of terminals on the device.
- 5. NE is the number of terminals on the "E" side of the package (or Y-direction).
- 6. ND is the number of terminals on the "D" side of the package (or X-direction). ND = (N/2)-NE.
- 7. Inward end of terminal may be square or circular in shape with radius (b/2) as shown.
- 8. If two values are listed, multiple exposed pad options are available. Refer to device-specific datasheet.

# **Package Outline Drawing**

### L12.4x4B

12 LEAD DUAL FLAT NO-LEAD PLASTIC PACKAGE Rev 0, 06/08





#### TYPICAL RECOMMENDED LAND PATTERN





SIDE VIEW

# DETAIL "X"

0.2 REF

С

#### NOTES:

- 1. Dimensions are in millimeters. Dimensions in ( ) for Reference Only.
- 2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
- 3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
- 4. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 5. Tiebar shown (if present) is a non-functional feature.
- The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.